

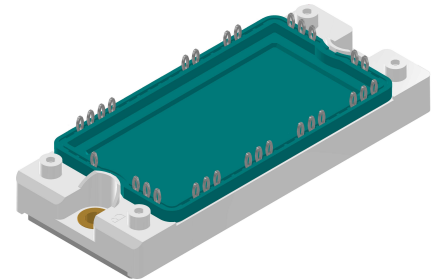
# High Voltage Standard Rectifier Module

3~ Rectifier	Brake Chopper
$V_{RRM} = 2200\text{ V}$	$V_{CES} = 1700\text{ V}$
$I_{DAV} = 360\text{ A}$	$I_{C25} = 200\text{ A}$
$I_{FSM} = 1900\text{ A}$	$V_{CE(sat)} = 2.1\text{ V}$


3~ Rectifier Bridge + Brake Unit + NTC

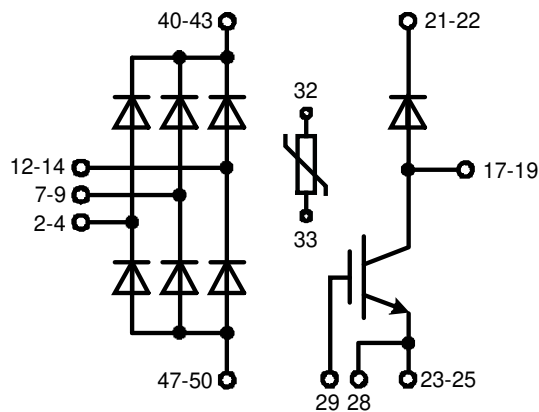
Part number

**MDNA360UB2200PTED**



Backside: isolated

 E72873



## Features / Advantages:

- Brake with Infineon IGBT<sup>3</sup>

## Applications:

- 3~ Rectifier with brake unit for drive inverters

## Package: E2-Pack

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- PressFit-Pins for PCB mounting
- Height: 17 mm
- Base plate: Copper internally DCB isolated
- Advanced power cycling
- Phase Change Material available

## Disclaimer Notice

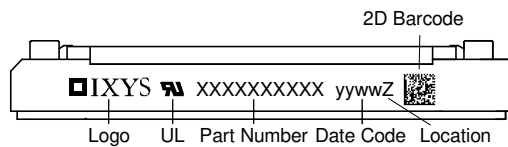
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Rectifier				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
$V_{RSM}$	max. non-repetitive reverse blocking voltage					2300	V
$V_{RRM}$	max. repetitive reverse blocking voltage					2200	V
$I_R$	reverse current	$V_R = 2200$ V		$T_{VJ} = 25^\circ\text{C}$		100	$\mu\text{A}$
		$V_R = 2200$ V		$T_{VJ} = 150^\circ\text{C}$		3	mA
$V_F$	forward voltage drop	$I_F = 120$ A		$T_{VJ} = 25^\circ\text{C}$		1.25	V
		$I_F = 360$ A				1.80	V
		$I_F = 120$ A		$T_{VJ} = 125^\circ\text{C}$		1.23	V
		$I_F = 360$ A				1.98	V
$I_{DAV}$	bridge output current	$T_C = 85^\circ\text{C}$		$T_{VJ} = 150^\circ\text{C}$		360	A
		rectangular	$d = \frac{1}{3}$				
$V_{FO}$	threshold voltage			$T_{VJ} = 150^\circ\text{C}$		0.82	V
$r_F$	slope resistance					3.4	m $\Omega$
$R_{thJC}$	thermal resistance junction to case					0.25	K/W
$R_{thCH}$	thermal resistance case to heatsink				0.1		K/W
$P_{tot}$	total power dissipation			$T_C = 25^\circ\text{C}$		500	W
$I_{FSM}$	max. forward surge current	$t = 10$ ms; (50 Hz), sine		$T_{VJ} = 45^\circ\text{C}$		1.90	kA
		$t = 8,3$ ms; (60 Hz), sine		$V_R = 0$ V		2.05	kA
		$t = 10$ ms; (50 Hz), sine		$T_{VJ} = 150^\circ\text{C}$		1.62	kA
		$t = 8,3$ ms; (60 Hz), sine		$V_R = 0$ V		1.75	kA
$I^2t$	value for fusing	$t = 10$ ms; (50 Hz), sine		$T_{VJ} = 45^\circ\text{C}$		18.1	kA <sup>2</sup> s
		$t = 8,3$ ms; (60 Hz), sine		$V_R = 0$ V		17.5	kA <sup>2</sup> s
		$t = 10$ ms; (50 Hz), sine		$T_{VJ} = 150^\circ\text{C}$		13.0	kA <sup>2</sup> s
		$t = 8,3$ ms; (60 Hz), sine		$V_R = 0$ V		12.7	kA <sup>2</sup> s
$C_J$	junction capacitance	$V_R = 400$ V; $f = 1$ MHz		$T_{VJ} = 25^\circ\text{C}$		73	pF

Brake IGBT + Diode				Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit	
$V_{CES}$	collector emitter voltage	$T_{VJ} = 25^{\circ}\text{C}$			1700	V	
$V_{GES}$	max. DC gate voltage				$\pm 20$	V	
$V_{GEM}$	max. transient gate emitter voltage				$\pm 30$	V	
$I_{C25}$	collector current	$T_C = 25^{\circ}\text{C}$			200	A	
$I_{C100}$		$T_C = 100^{\circ}\text{C}$			135	A	
$P_{tot}$	total power dissipation	$T_C = 25^{\circ}\text{C}$			935	W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 150\text{ A}; V_{GE} = 15\text{ V}$			2.1	V	
					3.2	V	
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 4\text{ mA}; V_{GE} = V_{CE}$	5.5	6.0	6.5	V	
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$			0.12	mA	
					2.3	mA	
$I_{GES}$	gate emitter leakage current	$V_{GE} = \pm 20\text{ V}$			500	nA	
$Q_{G(on)}$	total gate charge	$V_{CE} = 900\text{ V}; V_{GE} = 15\text{ V}; I_C = 150\text{ A}$		310		nC	
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 900\text{ V}; I_C = 150\text{ A}$ $V_{GE} = \pm 15\text{ V}; R_G = 10\ \Omega$	$T_{VJ} = 125^{\circ}\text{C}$		120	ns	
$t_r$	current rise time				80	ns	
$t_{d(off)}$	turn-off delay time				400	ns	
$t_f$	current fall time				150	ns	
$E_{on}$	turn-on energy per pulse				45	mJ	
$E_{off}$	turn-off energy per pulse				50	mJ	
<b>RBSOA</b>	reverse bias safe operating area	$V_{GE} = \pm 15\text{ V}; R_G = 10\ \Omega$					
$I_{CM}$		$V_{CEK} = 1700\text{ V}$			280	A	
<b>SCSOA</b>	short circuit safe operating area	$V_{CEK} = 1700\text{ V}$					
$t_{SC}$	short circuit duration	$V_{CE} = 1300\text{ V}; V_{GE} = \pm 15$			10	$\mu\text{s}$	
$I_{SC}$	short circuit current	$R_G = 10\ \Omega$ ; non-repetitive		400		A	
$R_{thJC}$	thermal resistance junction to case				0.16	K/W	
$R_{thCH}$	thermal resistance case to heatsink			0.25		K/W	
Brake Diode							
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 25^{\circ}\text{C}$			1700	V	
$I_{F25}$	forward current	$T_C = 25^{\circ}\text{C}$			145	A	
$I_{F100}$		$T_C = 100^{\circ}\text{C}$			90	A	
$V_F$	forward voltage	$I_F = 100\text{ A}$			2.20	V	
					2.00	V	
$I_R$	reverse current	$V_R = V_{RRM}$			tbd	mA	
					tbd	mA	
$Q_{rr}$	reverse recovery charge	$V_R = 900\text{ V}$ $-di_f/dt = 2500\text{ A}/\mu\text{s}$ $I_F = 100\text{ A}; V_{GE} = 0\text{ V}$	$T_{VJ} = 125^{\circ}\text{C}$		30	$\mu\text{C}$	
$I_{RM}$	max. reverse recovery current				60	A	
$t_{rr}$	reverse recovery time				200	ns	
$E_{rec}$	reverse recovery energy				11	mJ	
$R_{thJC}$	thermal resistance junction to case				0.39	K/W	
$R_{thCH}$	thermal resistance case to heatsink			0.62		K/W	

Package E2-Pack		Ratings				
Symbol	Definition	Conditions	min.	typ.	max.	Unit
$I_{RMS}$	RMS current	per terminal			30	A
$T_{VJ}$	virtual junction temperature		-40		150	°C
$T_{op}$	operation temperature		-40		125	°C
$T_{stg}$	storage temperature		-40		125	°C
<b>Weight</b>				176		g
$M_D$	mounting torque		3		6	Nm
$d_{Spp/ App}$	creepage distance on surface / striking distance through air	terminal to terminal	6.0			mm
$d_{Spb/ Apb}$		terminal to backside	12.0			mm
$V_{ISOL}$	isolation voltage	t = 1 second 50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA	3600			V
		t = 1 minute	3000			V



### Part description

M = Module  
 D = Diode  
 N = High Voltage Standard Rectifier  
 A = ( $\geq 2000V$ )  
 360 = Current Rating [A]  
 UB = 3- Rectifier Bridge + Brake Unit  
 2200 = Reverse Voltage [V]  
 PT = PressFit-Pin, Thermistor  
 ED = E2-Pack  
 - = Hyphen  
 PC = Phase Change Material

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MDNA360UB2200PTED	MDNA360UB2200PTED	Blister	28	515682
Alternative	MDNA360UB2200PTED-PC	MDNA360UB2200PTED	Blister	28	514541

### Temperature Sensor NTC

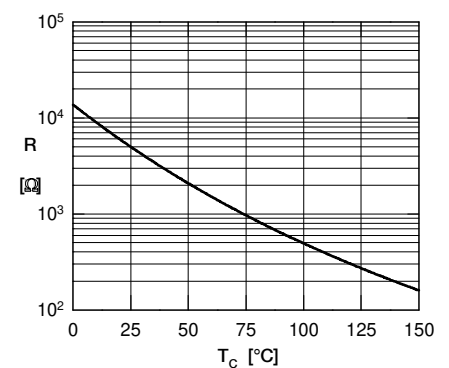
Symbol	Definition	Conditions	min.	typ.	max.	Unit
$R_{25}$	resistance	$T_{VJ} = 25^\circ$	4.85	5	5.15	k $\Omega$
$B_{25/50}$	temperature coefficient			3375		K

### Equivalent Circuits for Simulation

\* on die level

$T_{VJ} = 150^\circ C$

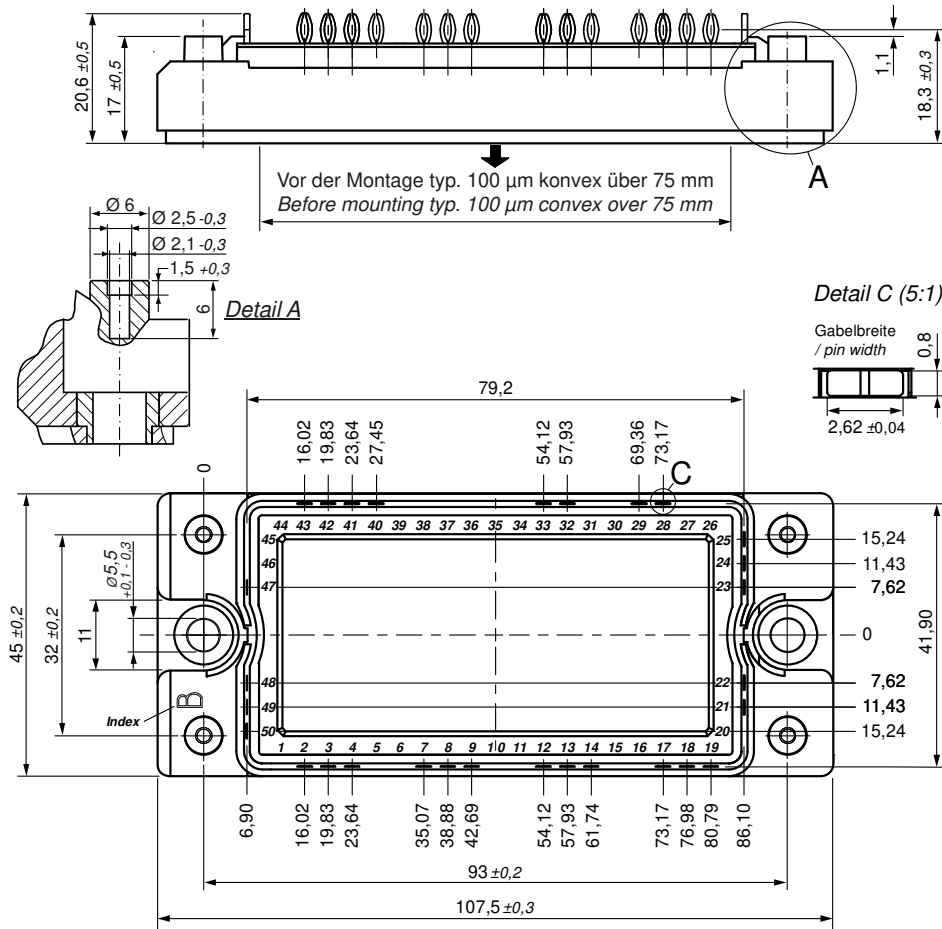
		Rectifier	Brake IGBT +	Brake Diode	
$V_0$	threshold voltage	0.82	1.1	1.25	V
$R_0$	slope resistance *	1.5	9.2	8.5	m $\Omega$



Typ. NTC resistance vs. temperature



**Outlines E2-Pack**

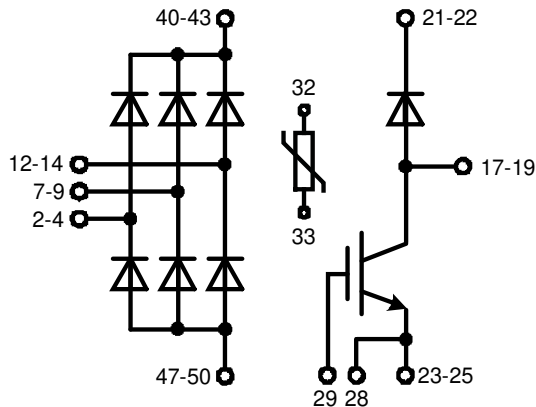


**Bemerkung / Note:**

- Nicht tolerierte Maße nach / Measure without tolerances according DIN ISO 2768-T1-m
- PCB-Lochmuster / PCB hole pattern: **see pin position**
- Toleranz Pin-Position und PCB-Lochmuster / Tolerance of pin position and PCB hole pattern:  $\oplus 0.1$
- Bohrlochdurchmesser / Diameter of drill: **Ø 2.35 mm**
- Endlochdurchmesser / Diameter of plated holes: **Ø 2.14 - 2.29 mm** (Cu thickness in via typ. 50 µm)
- Beschichtung / Plating: **chem. Sn max. 15 µm**
- Einpresskraft / Insert Force: per terminal with a typ. insert speed of 7 mm/s: **typ. 90 N**
- Weitere Angaben / Further information: [www.ixys.com](http://www.ixys.com) **Application note IXAN0077**
- Montageanleitung / Mounting instruction: [www.ixys.com](http://www.ixys.com) **Application note IXAN0024**

**Detail A:** PCB-Montage / Mounting on PCB<sup>L</sup>

- Empfohlene, selbstschneidende Schraube / Recommended, self-tapping screw: **EJOT PT®** (Größe / size: **K25**)<sup>L</sup>
- Max. Schraubenlänge / Max. screw length: **PCB-Dicke / thickness + 6 mm** (max. Lochtiefe / hole depth)<sup>L</sup>
- Empfohlenes Drehmoment / Recommended mounting torque: **1.5 Nm**





**Rectifier**

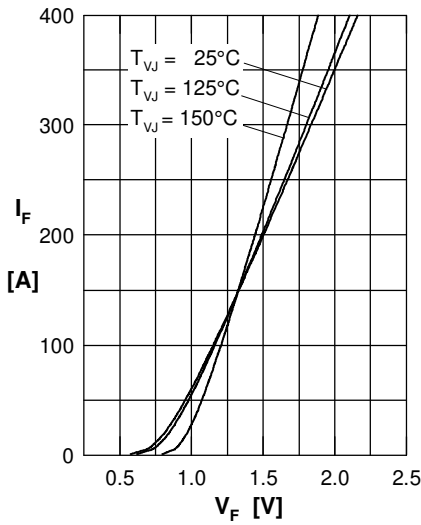


Fig. 1 Forward current versus voltage drop per diode

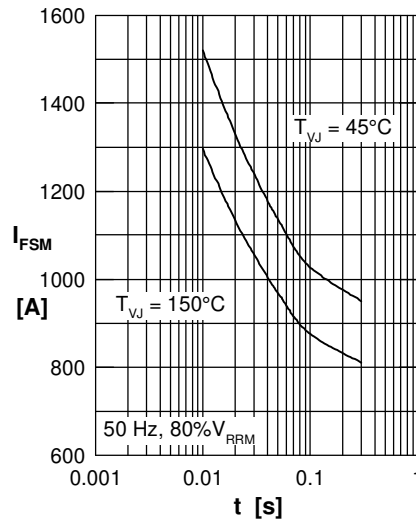


Fig. 2 Surge overload current vs. time per diode

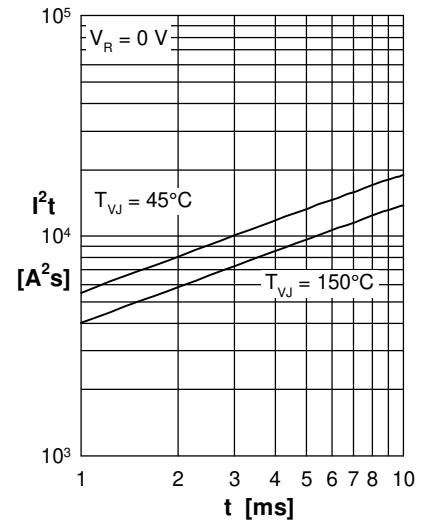


Fig. 3  $I^2t$  versus time per diode

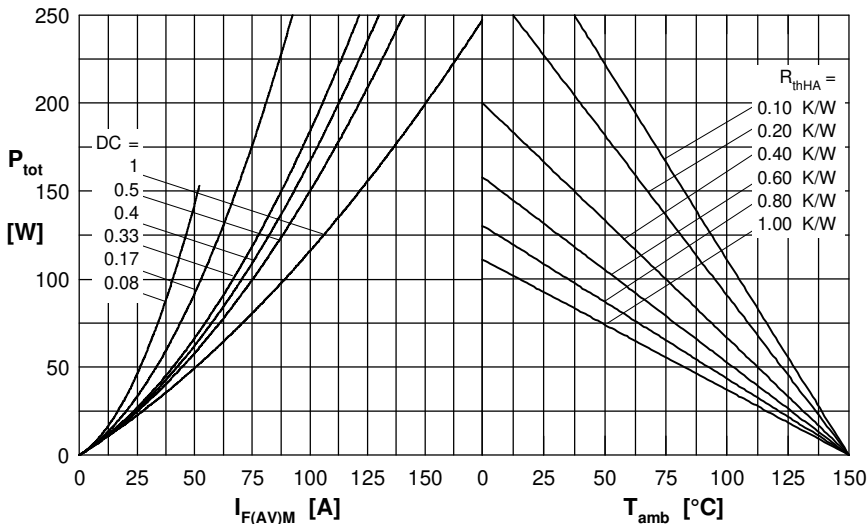


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

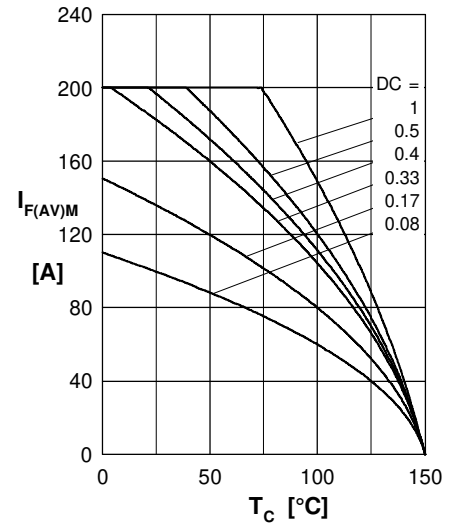


Fig. 5 Max. forward current vs. case temperature per diode

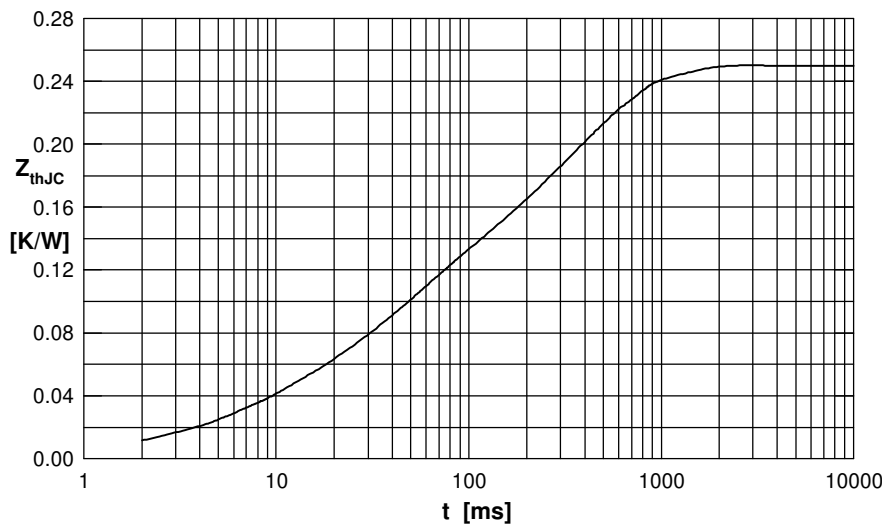


Fig. 6 Transient thermal impedance junction to case vs. time per diode

Constants for  $Z_{thJC}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.020	0.006
2	0.003	0.007
3	0.080	0.037
4	0.147	0.360